As a below named Inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled **A Method To Reduce Particle Level For Dry-Etch**

the specification of which (check one)

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X is attached hereto.			
was filed on	the state of the s	A THE STATE OF THE	_
Application Serial No.			-
and was amended on (if app			_
I hereby state that I have reviewed and unamended by any amendment referred to ab	derstand the contents of the abo	ove Identified specification including	the claims, as
I acknowledge the duty to disclose inform 37, Code of Federal Regulations, §1.56(a)	ation which is material to the en	xamination of this application in acco	rdance with Title
I hereby claim foreign priority benefits und inventor's certificate listed below and have a filing date before that of the application	e also identified below any fore	e §119 of any foreign application(s) fign application for patent or inventor	or patent or s certificate having
Prior Foreign Application(s)		Priority Cla	imed:
(Number)	(Country)	(Day/Month/Year Filed)	
(Number)	(Country)	(Day/Month/Year Filed)	
I hereby claim the benefit under Title 35, as the subject matter of each of the claims provided by the first paragraph of Title 35 defined in Title 37, Code of Federal Regunational or PCT international filing date of	of this application is not disclo United States Code, §112, I a lations. §1.56(a) which occurre	y United States application(s) listed by used in the prior United States application acknowledge the duty to disclose mated between the filing date of the prior	elow and, insofar tion in the manner erial information as application and the
(Application Serial No.)	(Filing Date) (Status)	(patented, pending, abandoned)	
I hereby declare that all statements made lebelief are believed to be true, and further the like so made are punishable by fine or that such willful false statements may jeop	that these statements were mad	e with the knowledge that willful fals	e statements and
POWER OF ATTORNEY: As a named in application and transact all business in the	eventor, I hereby appoint the fore Patent and Trademark Office	ollowing attorney(s) and/or agent(s) to connected therewith. (list name & reg	prosecute this istration no.)
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